

# out of the **B** **X**

## University of Florida Digital Logic and Computer Systems Parts List

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*Last Updated May 10, 2017*



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# Parts List

1. Toolbox
2. Out of the Box MAX V Development Board with Dual Seven Segment Display
3. Out of the Box Large Solderless Breadboard
4. Single Panel Solderless Breadboard
5. 350 Pc. Jumper Wire Kit
6. Digital Multimeter
7. Out of the Box Flux
8. USB A to B Cable
9. Breadboard Parts Bag
  - a. 4 Power Screw Terminals
  - b. 4 Rubber Feet
10. Accessory Kit Bag
  - a. USB B connector
  - b. Solder wick
  - c. Three 40-pin headers
  - d. SPDT Switch
  - e. Panel of 3 8x 1k DIP resistors
  - f. SPDT Switch Breakout Board
  - g. 5x 1K ¼W resistors
11. Anti-Static Foam Bag
 

a. 74HC00	(QTY 5)
b. 74HC02	(QTY 5)
c. 74HC04	(QTY 2)
d. 74HC08	(QTY 2)
e. 74HC10	(QTY 1)
f. 74HC11	(QTY 1)
g. 74HC74	(QTY 3)
h. 74HC153	(QTY 2)
i. 8x DIP Switch	(QTY 3)
j. LED Bar Graph	(QTY 3)
k. 32k x8 SRAM	(QTY 1)
l. 2.2k SIP Resistors	(QTY 4)

# Locating Parts

All of the integrated circuits or ICs as well as several other leaded parts are pressed into antistatic foam as seen below.

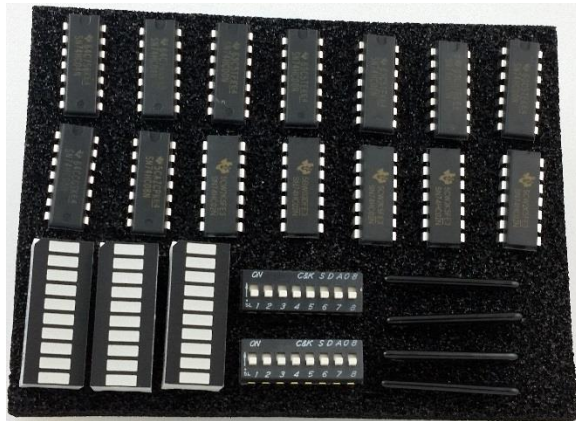


Figure 1: Foam Top

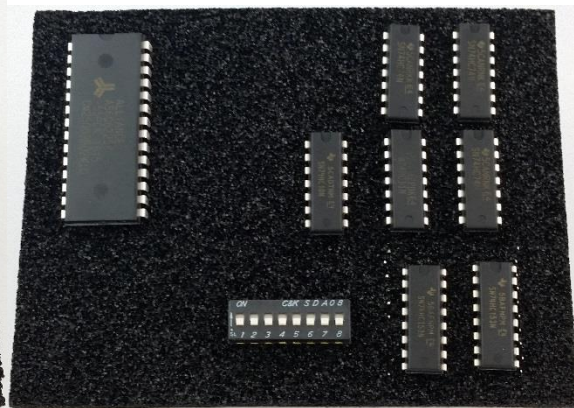
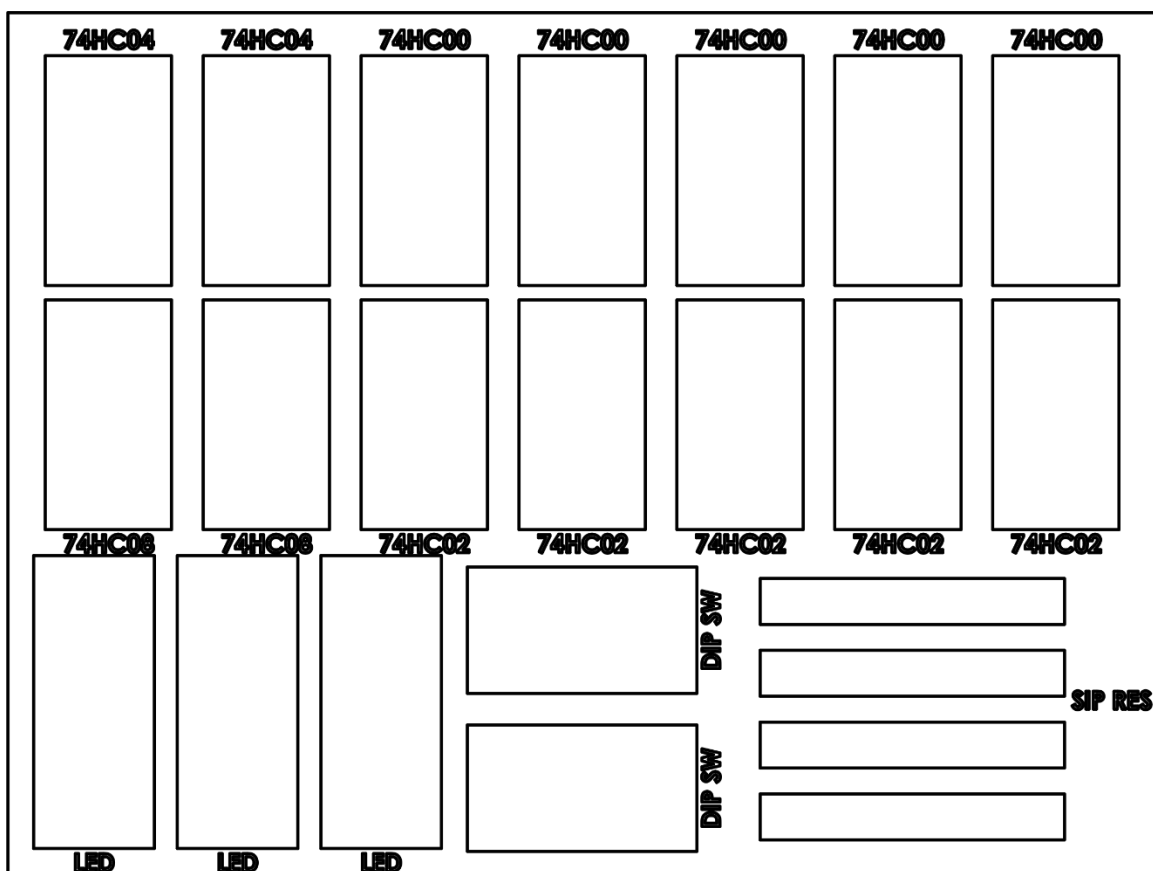


Figure 2: Foam Bottom

# Foam Top Part Locations



# Foam Bottom Part Locations

